

MAGICARD ID CARD PRINTERS	PRODUCT RECYCLING PASSPORT	
	Brand Name(s):	MAGICARD
Product Name :	Blank HoloKote™ Custom Key with locking capability for Rio2/Tango2 model	
Product Codes :	M9006-864E	
Date :	30 March 2006	
Contact for further information request: www.ultramagicard.com		
<i>Product(s) contain(s) / has</i>	<i>Substances</i>	<i>Y/N Comments</i>
Batteries		
External	Mercury/NiCad/Lithium/Other	NO
Internal	Mercury/NiCad/Lithium/Other	↓ NO See §1 for further information
Parts containing		
	Mercury	↓ NO See §2 for further information
	Lead	NO
	Cadmium	NO
	Printed circuit board assembly > 10 cm ²	YES
	Printed circuit board assembly From cell phones or similar	NO
	Liquid or paste toner cartridge	NO
	Hexavalent chromium	NO
	Capacitors with PCB's	↓ NO See §3 for further information
	Capacitors with substances of concern* + height > 25mm or proportionately similar volume	↓ NO See §4 for further information
	Gas discharge lamps	NO
	Backlight lamps of LCD/TFT	NO
	Mercury contained in Backlighting lamps	NO

	Plastic containing brominated flame retardants other than in Printed Circuit Assemblies		NO
	Liquid Crystal Displays with a surface greater than 100 cm ²		NO
	Asbestos		NO
	Refractory ceramic fibres		NO
	Radio-active substances	↓	NO See §5 for further information
	Beryllium Oxide	↓	NO See §6 for further information
	Other forms of Beryllium		NO
Compartments/units/Part not in Annex 2 and are under or with			
	Pressure	↓	NO See §7 for further information
	Liquids	↓	NO See §8 for further information
	Gasses **	↓	NO See §9 for further information
	"Hidden" mechanical springs or other equivalent parts **	↓	NO See §10 for further information

↓ = arrow indicates the need for the location of the compartment/substances within the product. Location is needed at part level.

* Substance of concern other than PCB, to be specified/addressed further in the context of EU Directive 2002/96/EC (27 January 2003)(WEEE Directive) Annex 2 National requirements and European developments

** Same need as for maintenance, service manuals and installation for safety purposes.

ALL VALUES MUST BE GIVEN IN METRICS

1. Internal Batteries

Type: NONE

Location:

2. Mercury

Location: NONE

3. Capacitors with polychlorobiphenyl (PCB)

Location: NONE

4. Capacitors with substance(s) of concern other than PCB

Substance(s): NONE

Location:

5. Radio-active substances

Source: NONE

Activity:

Location:

6. Beryllium oxide

Location: NONE

7. Pressure containers

Type of container(s): NONE

Volume:

Pressure:

Substances:

Location:

Method of discharge:

8. Liquids

Type of liquid(s): NONE

Volume / Weight:

Location:

Properties:

Method of discharge:

9. Gasses

Type of gasses:

NONE

Volume / Weight:

Pressure:

Properties:

Location:

Method of discharge:

10. "Hidden" Mechanical springs or equivalent

Type of risk:

NONE

Location:

Method of handling:

11. Comments